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STPS15H100C-Y

Automotive high voltage power Schottky rectifier

Features

- Negligible switching losses
- Low leakage current
- Good trade off between leakage current and forward voltage drop
- Low thermal resistance
- Avalanche capability specified
- AEC-Q101 qualified

Description

Dual center tab Schottky rectifier suited for switched mode power supply and high frequency DC to DC converters.

Packaged in DPAK, this device is intended for use in high frequency inverters in automotive market.

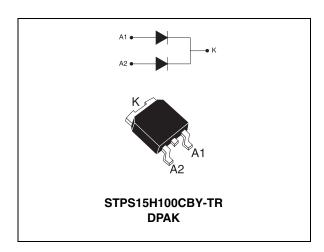


Table 1. Device summary

Symbol	Value
I _{F(AV)}	2 x 7.5 A
V_{RRM}	100 V
T _{j (max)}	175 °C
V _{F(max)}	0.67 V

Characteristics STPS15H100C-Y

1 Characteristics

Table 2. Absolute Ratings (limiting values, per diode)

Symbol	Parameter	Value	Unit		
V_{RRM}	Repetitive peak reverse voltage			100	V
I _{F(RMS)}	Forward rms current			10	Α
	Average forward current	T _c = 135 °C	Per diode	7.5	Α
I _{F(AV)}	Average forward current	$\delta = 0.5$	Per device	15	А
I _{FSM}	Surge non repetitive forward current	$t_p = 10 \text{ ms si}$	nusoidal	75	Α
I _{RRM}	Peak repetitive reverse current	t _p = 2 μs squ	are F= 1 kHz	1	Α
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \mu s T_j = 25 ^{\circ}C$			6600	W
T _{stg}	Storage temperature range	- 65 to + 175	°C		
T _j	Operating junction temperature (1) range			-40 to +175	°C
dV/dt	Critical rate of rise of reverse voltage			10000	V/µs

^{1.} $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit	
В	Junction to case	Per diode	4	
R _{th(j-c)}	Junction to case	Total		°C/W
R _{th(c)}	Coupling		0.7	

When the diodes 1 and 2 are used simultaneously:

 $\Delta T_i(diode 1) = P(diode 1) \times R_{th(i-c)}(Per diode) + P(diode 2) \times R_{th(c)}$

Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage	T _j = 25 °C	V - V			3	μΑ
'R`	current	T _j = 125 °C	$T_j = 125 ^{\circ}\text{C}$ $V_R = V_{RRM}$		1.3	4	mA
	T _j = 25 °C	I _F = 7.5 A			0.8		
	V _F (⁽¹⁾) Forward voltage drop	T _j = 125 °C	I _F = 7.5 A		0.62	0.67	
ν (1)\		T _j = 25 °C	I _F = 12 A			0.85	V
v _{E(', ')}		T _j = 125 °C	I _F = 12 A		0.68	0.73	V
		T _j = 25 °C	I _F = 15 A			0.89	
		T _j = 125 °C	I _F = 15 A		0.71	0.76	

^{1.} Pulse test: tp = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation:

$$P = 0.58 \text{ x } I_{F(AV)} + 0.012 I_{F}^{2}_{(RMS)}$$

STPS15H100C-Y Characteristics

Figure 1. Conduction losses versus average Figure 2. Average forward current versus ambient temperature (δ = 0.5)

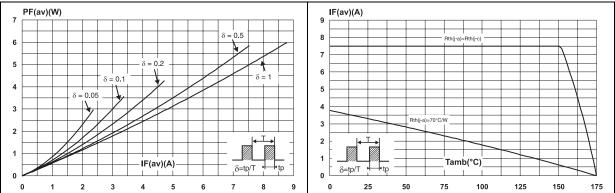


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature

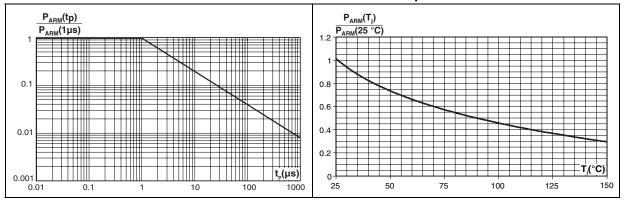
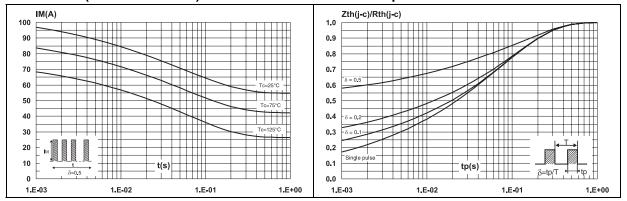


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)

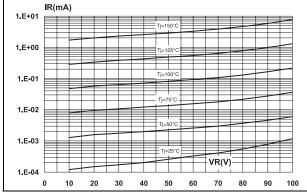
Figure 6. Relative variation of thermal impedance junction to case versus pulse duration



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Figure 7. Reverse leakage current versus reverse voltage applied (typical values)

Figure 8. Junction capacitance versus reverse voltage applied (typical values)



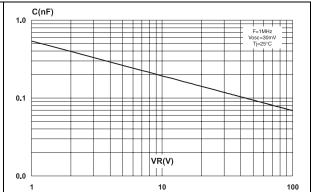
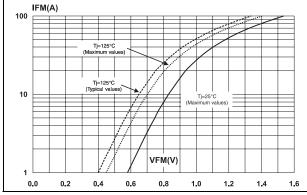
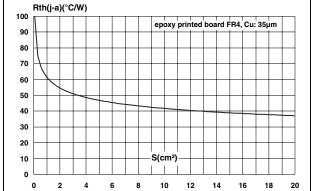


Figure 9. Forward voltage drop versus forward current

Figure 10. Thermal resistance junction to ambient versus copper surface under tab





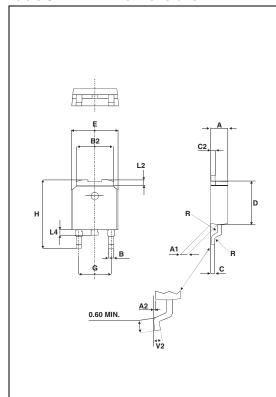
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2 Package information

- Epoxy meets UL94,V0
- Lead-free packages

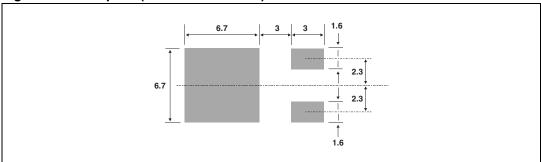
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 5. DPAK dimensions



	Dimensions				
Ref.	Millim	neters	Inches		
	Min.	Max.	Min.	Max.	
Α	2.20	2.40	0.086	0.094	
A1	0.90	1.10	0.035	0.043	
A2	0.03	0.23	0.001	0.009	
В	0.64	0.90	0.025	0.035	
B2	5.20	5.40	0.204	0.212	
С	0.45	0.60	0.017	0.023	
C2	0.48	0.60	0.018	0.023	
D	6.00	6.20	0.236	0.244	
Е	6.40	6.60	0.251	0.259	
G	4.40	4.60	0.173	0.181	
Н	9.35	10.10	0.368	0.397	
L2	0.80	typ.	0.03	1 typ.	
L4	0.60	1.00	0.023	0.039	
V2	0°	8°	0°	8°	

Figure 11. Footprint (dimensions in mm)



3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS15H100CBY-TR	S15H100Y	DPAK	0.30 g	75	Tape and reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
04-Nov-2011	1	Initial release.

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